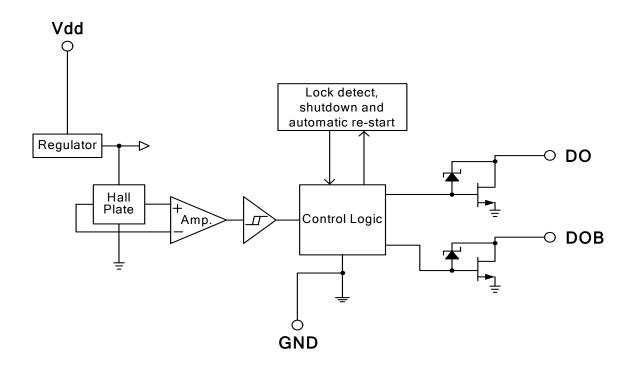


## **Pin Descriptions**

Pin Name	Description
Vdd	Input Power
DO	Output Pin
DOB	Output Pin
GND	Ground
NC	Not Connected

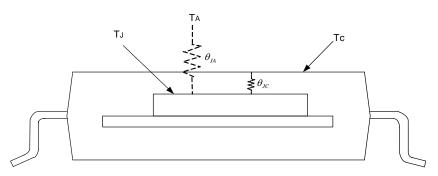
## **Functional Block Diagram**





# Absolute Maximum Ratings (T<sub>A</sub> = 25°C)

Symbol	Character	Rating	Unit		
Vdd	Supply Voltage			24	V
		1	SIP-4L	500	mA
Ι <sub>Ο</sub>	Output Current	IO (AVE)	SOT89-5L	500	mA
		I <sub>O (PEAK)</sub>		700	mA
P <sub>D</sub>	Power Dissipation	SIP-4L		550	mW
гD	Fower Dissipation	SOT89-5L		800	mW
T <sub>ST</sub>	Storage Temperature			-55 ~ 150	°C
ТJ	Maximum Junction Temperature	150	°C		
$\theta_{JA}$	Thermal Resistance Junction to	SIP-4L		227	°C/W
UJA	Case (Note 2)	SOT89-5L		156	°C/W



Notes: 2.  $\theta_{JA}$  should be confirmed with heat sink thermal resistance. If there is no heat sink contact,  $\theta_{JA}$  will almost be the same as  $\theta_{JC}$ .

#### **Recommended Operating Conditions**

Symbol	Characteristic	Conditions	Min	Max	Unit
Vdd	Supply Voltage	Operating	3.8	20	V
T <sub>A</sub>	Operating Ambient Temperature	Operating	-40	100	°C



#### **Electrical Characteristics** (T<sub>A</sub> = 25 °C, Vdd = 12V, unless otherwise specified)

Symbol	Characteristics	Conditions	Min	Тур.	Max	Unit
ldd	Supply Current	Operating	-	2.0	4.0	mA
I <sub>OFF</sub>	Output Leakage Current	$V_{OUT} = 24V$	-	< 0.1	10	μA
T <sub>RLP-ON</sub>	Rotor Lock Protection On Time		0.4	0.5	0.6	Sec
T <sub>RLP-OFF</sub>	Rotor Lock Protection Off Time		2.4	3	3.6	Sec
N/	Output Saturation Voltage	$I_0 = 300 \text{mA}$	-	375	500	mV
$V_{OUT(SAT)}$	Output Saturation Voltage	$I_0 = 500 mA$	-	625	900	mv
R <sub>DS(ON)</sub>	Output On Resistance	$I_0 = 300 \text{mA}$	-	1.25	1.67	ohm
Vz	Output Zener-Breakdown Voltage		35	42	60	V

#### **Truth Table**

IN-	IN+	СТ	OUT1	OUT2	Mode
Н	L	L	Н	L	Rotating
L	Н	L	L	Н	Rotating
-	-	Н	off	off	Lockup protection activated

## Magnetic Characteristics (T<sub>A</sub> = 25 °C, Vdd = 12V, unless otherwise specified, Note 3)

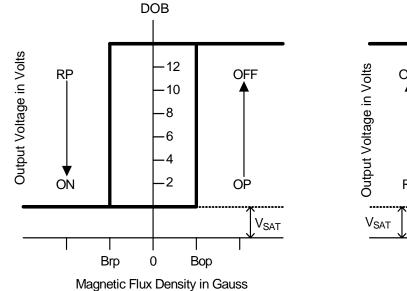
(1mT = 10 Gauss)

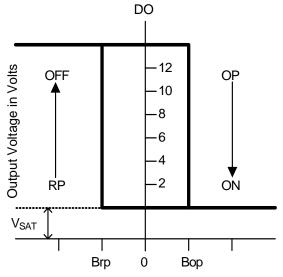
Symbol	Characteristics	Min	Тур.	Max	Unit
Вор	Operation Point	10	30	60	Gauss
Brp	Release Point	-60	-30	-10	Gauss
Bhy	Hysteresis	-	60	-	Gauss

Notes: 3. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.

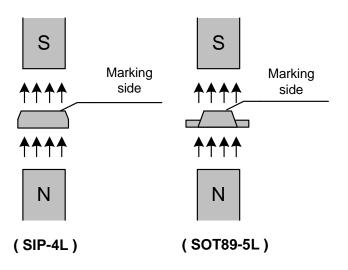


### **Operating Characteristics**





Magnetic Flux Density in Gauss

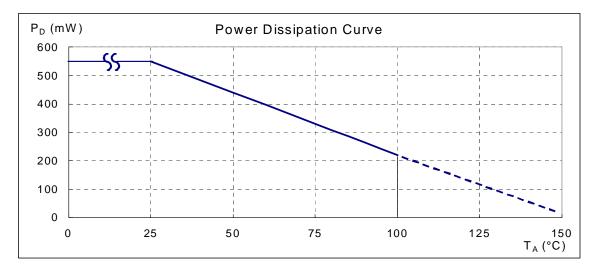




# **Performance Characteristics**

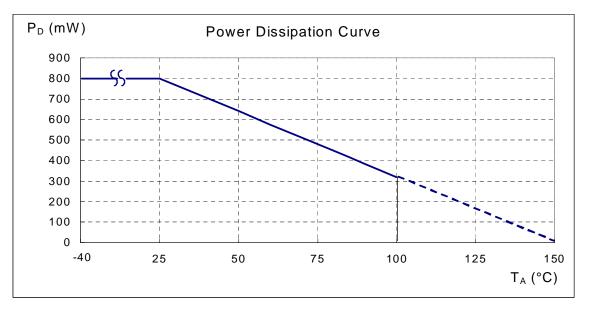
(1) S	IP-4L
-------	-------

T <sub>A</sub> (°C)	25	50	60	70	80	85	90	95	100
P <sub>D</sub> (mW)	550	440	396	352	308	286	264	242	220
T <sub>A</sub> (°C)	105	110	115	120	125	130	135	140	150
P <sub>D</sub> (mW)	198	176	154	132	110	88	66	44	0



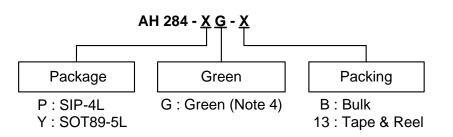
#### (2) SOT89-5L

T <sub>A</sub> (°C)	25	50	60	70	75	80	85	90	95	100
P <sub>D</sub> (mW)	800	640	576	512	480	448	416	384	352	320
T <sub>A</sub> (°C)	105	110	115	120	125	130	135	140	145	150
P <sub>D</sub> (mW)	288	256	224	192	160	128	96	64	32	0





#### **Ordering Information**



	Baakaga		Packago Packaging		Bulk	13" Tape and Reel		
	Device	Package Code	Packaging (Note 5, 6)	Quantity	Part Number Suffix	Quantity	Part Number Suffix	
PD-	AH284-PG-B	Р	SIP-4L	1000	-B	NA	NA	
<b>Pb</b> ,	AH284-YG-13	Y	SOT89-5L	NA	NA	2500/Tape & Reel	-13	

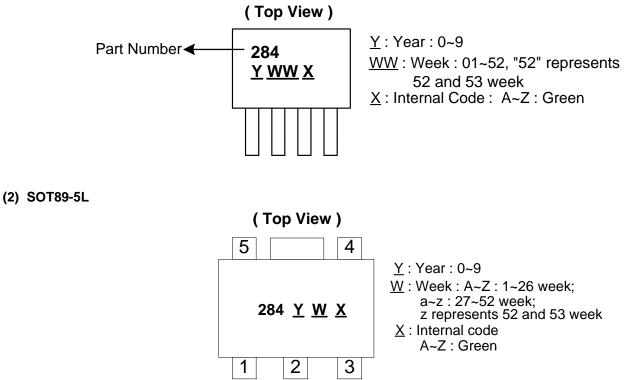
Notes: 4. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead\_free.html.

5. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

6. Reverse taping as shown on Diodes Inc. Surface Mount (SMD) Packaging document AP02007, which can be found on our website http://www.diodes.com/datasheets/ap02007.pdf.

#### **Marking Information**

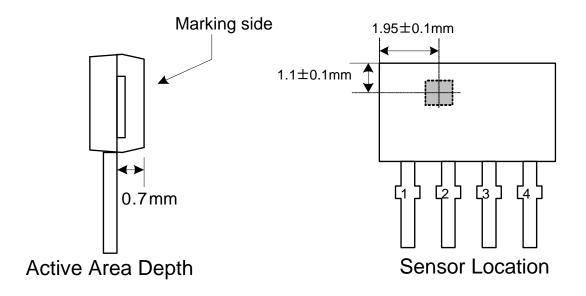
(1) SIP-4L



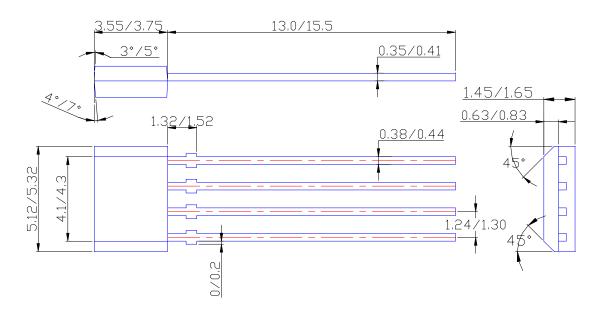


#### Package Outline Dimensions (All Dimensions in mm)

(1) Package type: SIP-4L



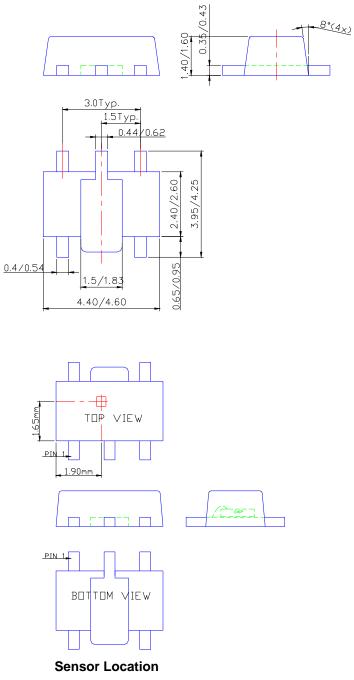
#### **Package Dimension**





## Package Outline Dimensions (Continued)

#### (2) Package type: SOT89-5L





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